



CALL FOR PAPERS

ICIEPT 2020
Mar 19-20, 2020
Dubai, UAE

The International Research Conference is a federated organization dedicated to bringing together a significant number of diverse scholarly events for presentation within the conference program. Events will run over a span of time during the conference depending on the number and length of the presentations.

ICIEPT 2020 : International Conference on Innovative Electronic Packaging Technologies is the premier interdisciplinary forum for the presentation of new advances and research results in the fields of Innovative Electronic Packaging Technologies. The conference will bring together leading academic scientists, researchers and scholars in the domain of interest from around the world. Topics of interest for submission include, but are not limited to:

Industrial robotics and automation
Modeling, analysis and simulation
of manufacturing processes
Sensor technology
Advanced forming manufacturing and
equipment
Mechanical control and information
processing technology
Micro electronic packaging
technology and equipment
Surface engineering and coatings
Materials forming
Materials machining
Welding and joining
Computer aided material design
Microwave processing of materials
Thermal engineering theory and
applications

High speed precision machining and
inspection technology
Micro machining technology
Laser processing technology
Bionic mechanisms and bio
manufacturing
Virtual and network manufacturing
Remanufacturing engineering
Sustainable manufacturing
technologies
Digital manufacture and management
Quality monitoring and control of
the manufacturing process
System analysis and industrial
engineering
Production and operation
management
Green supply chain
Manufacturing e-commerce system